



- NOTES:
1. PLATING THICKNESS:  
ELECTRO Ni: 1.27~8.89 MICRON (SOLDER PADS)  
ELECTRO Au: 0.70~1.20 MICRON (SOLDER PADS)
  2. CAMBER: 0.05mm MAX.
  3. \* MARK TO BE MATERIAL DIMENSION.
  4. EXPOSURE OF CERAMIC SURFACE OCCURRED BY MISALIGNMENT OF THE UPPER LAYER, SHALL BE ALLOWED.
  5. ■ PART TO BE SHOWN AS SIDE METALLIZED PATTERN.
  6. SEALING METHOD OF THIS PRODUCT SHALL BE SEAM WELD.

TOLERANCE XX ±1% XXX N.L.T.±0.13 ANGLES	REVISION	SBB ATTACHED EXCEPTIONS SHEET.			TITLE
	SCALE	DIMENSION	PROJECTION	CUSTOMER DWG NO.	REV.
	15 : 1	mm	3rd		
MATERIAL	APPROVED	CHECKED	ENGRG	CHECKED	DESIGNED
90%MIN. Al <sub>2</sub> O <sub>3</sub> (NA-301B BLACK)	Shigetomi	Tokushige	Ohba	Kumura	Sugi
			Oct.02.03	Oct.02.03	Oct.02.03
	PART NO. S5070XTAL2				REV. 0
	DWG NO.				SHT/OF 1/6